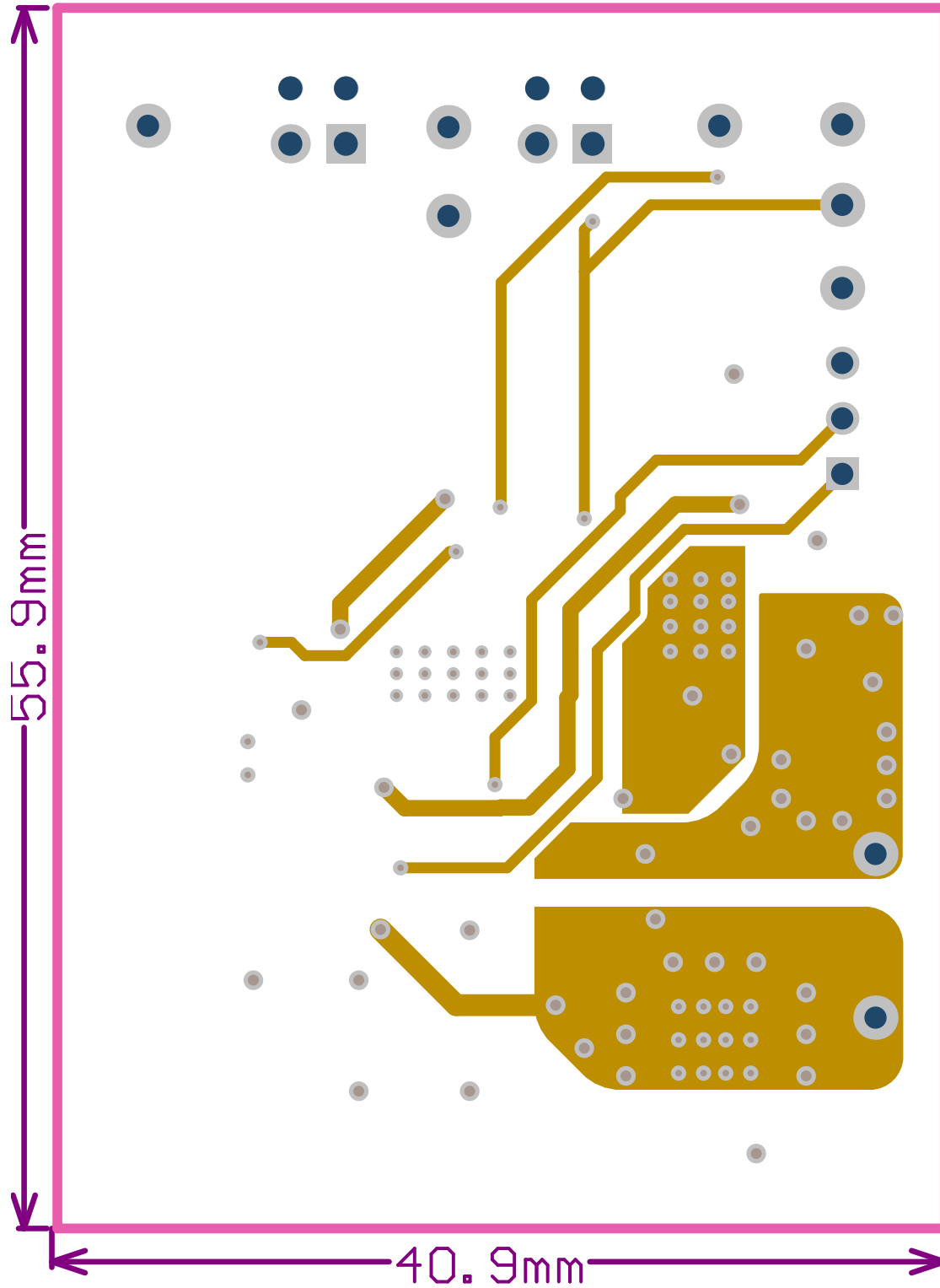
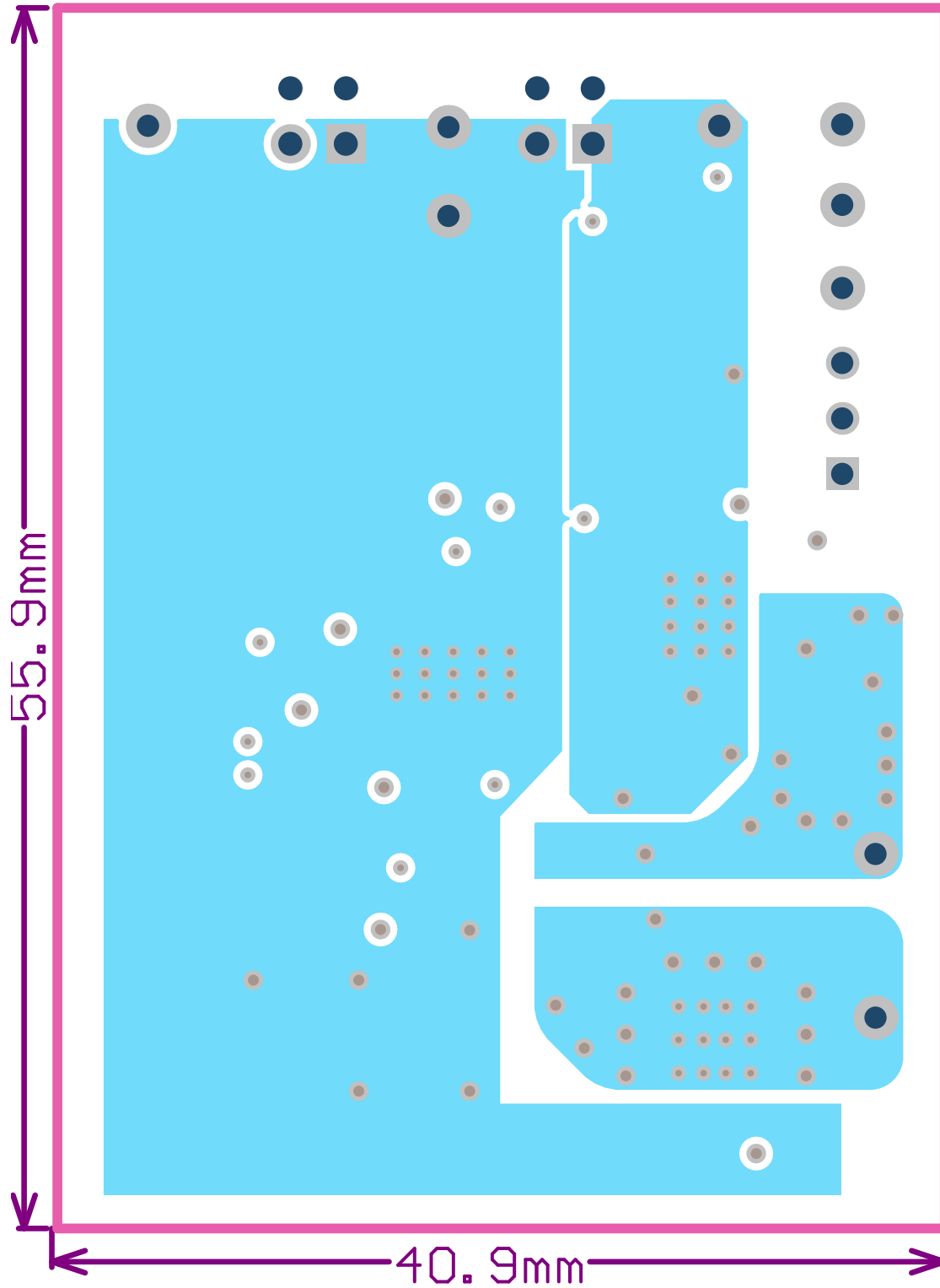


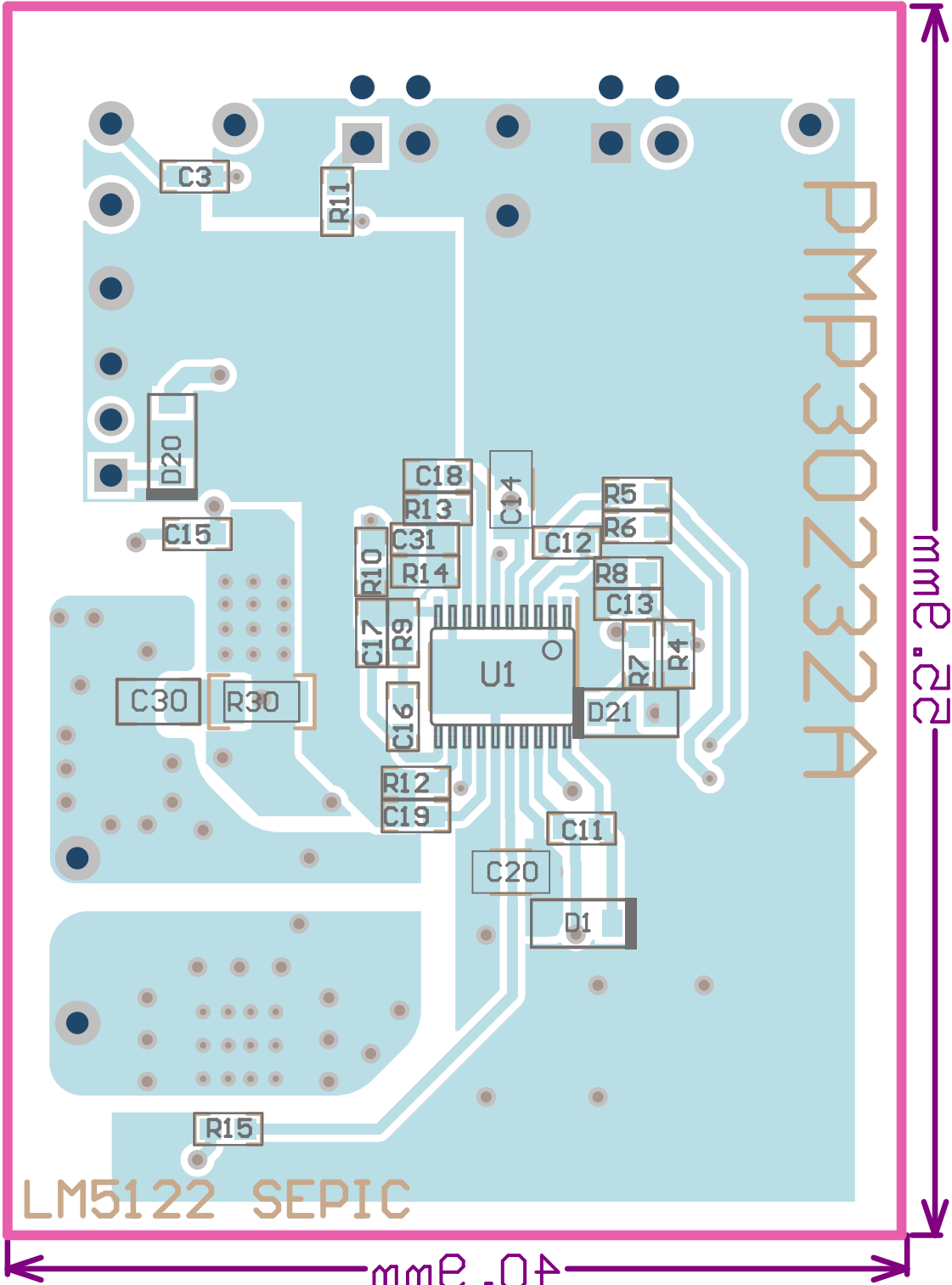
3/7/2017 16:58:12



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3\7\5017 1r:28:15



LM5122 SEPIC

PMP30232A

104.0 mm

22.0 mm

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